

4

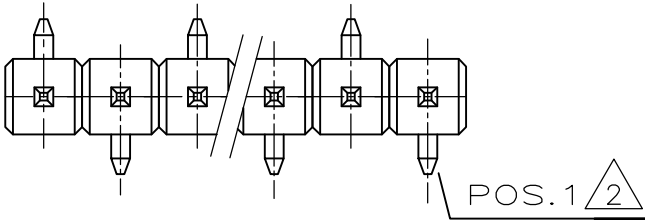
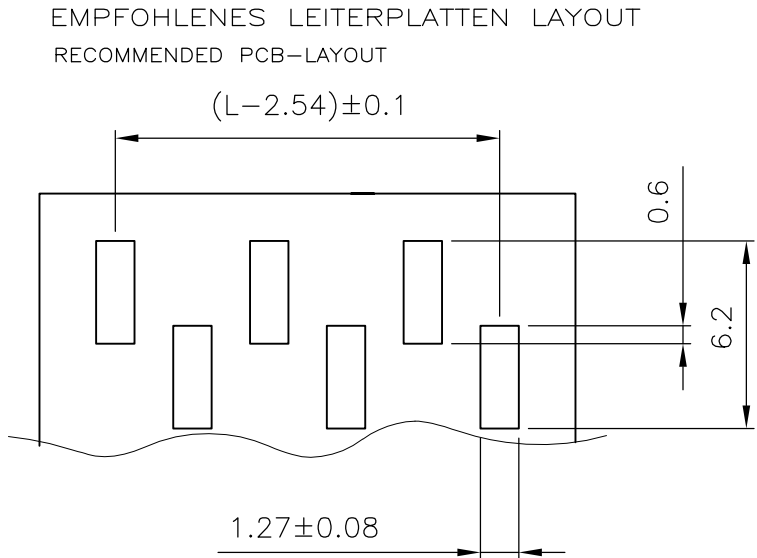
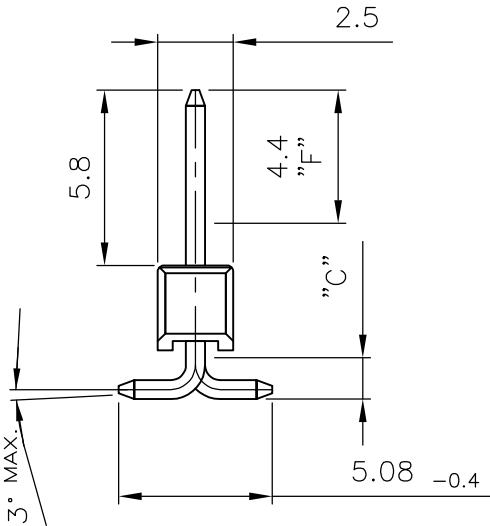
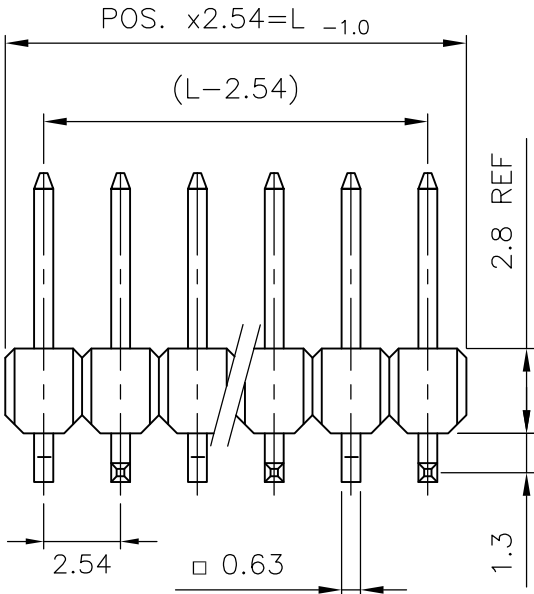
3

2

1

LOC	DIST	REVISIONS					
		P	LTR	DESCRIPTION	DATE	DWN	APVD
IR	—		D	CONTACT MATERIAL & PLATING CHANGE	20JUN2014	PS	JK

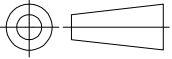
Pos.	L -0.9
-	-
3	7.62
4	10.16
5	12.7
6	15.24
7	17.78
8	20.32
9	22.86
10	25.4
11	27.94
12	30.48
13	33.02
14	35.56
15	38.1
16	40.64
17	43.18



1 MATING SIDE: AREA "F" MIN 0.7µm PdNi + MIN 0.1µm GOLD FLASH OVER 1.27µm NICKEL
SOLDER SIDE: 3.0 – 5.0 µm TIN OVER 1.27µm NICKEL

2 PAY ATTENTION THE POSITION OF 1st CONTACT

KONTAKTSTIFT / CONTACT PIN	CuZn	1	2
STIFTGEHÄUSE / PIN HOUSING	PCT	SCHWARZ / BLACK	1
BENENNUNG EINZELTEIL PART DESCRIPTION	WERKSTOFF MATERIAL	OBERFLÄCHE / FARBE SURFACE / COLOR	SI No

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN A.HO 24.03.95	 TE Connectivity			
		CHK M.SCHAARSCHMIDT 24.03.95				
DIMENSIONS: mm		APVD —	NAME AMPMODU II PINHEADER, SINGLE ROW, SMD—WITH PACKING TUBE.			
		PRODUCT SPEC 108—18012				
MATERIAL SEE TABLE		APPLICATION SPEC —	SIZE A3	CAGE CODE 00779	DRAWING NO C-966306	RESTRICTED TO —
TOLERANCES UNLESS OTHERWISE SPECIFIED: TOL ± 0.2		WEIGHT —	SCALE 2:1			
			SHEET 1 OF 2			
			REV D			

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[TE Connectivity:](#)

[966306-3](#)